

IN THE CLAIMS

Please amend claims 1 through 9 as follows:

1. (Amended) A stamp for use in a lithographic process, said stamp comprising:

a permeable stamp body with a first side and a second side, said first and second sides being opposed;

a structured printing face at said first side;

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a reservoir for a liquid at said second side; and

a permeable carrier body connecting said permeable stamp body and said reservoir,

wherein said liquid is directly transported from said reservoir through said permeable carrier body and said permeable stamp body to said structured printing face during use.

2. (Twice amended) The stamp of claim 1, wherein said permeable carrier body has a first side and a second, opposed side, with said permeable stamp body at said first side and said reservoir at said second side, said permeable carrier body having channels, at least a portion of which extend from said first side to said second side of said permeable carrier body.

3. (Amended) The stamp of claim 2, wherein said first side and said second side of said permeable stamp body lie at a distance from one another, and said channels at said first side of said permeable carrier body each have a diameter which is

smaller than said distance between said first side and said second side of said permeable stamp body.

4. (Amended) The stamp of claim 1, wherein said permeable carrier body has a porous material.

5. (Twice amended) The stamp of claim 1, wherein said reservoir has a porous material.

6. (Twice amended) The stamp of claim 1, wherein said stamp is cylindrical in shape, with said structured printing face forming an outer cylinder shell.

7. (Twice amended) A method of manufacturing an electronic component, comprising the steps of:

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(continued)

patterning a surface of a substrate by means of a stamp, said stamp having a structured printed face for use in a lithographic process; and

bringing said stamp into contact with said substrate such that a liquid cooperative with said structured printing face is transferred to a surface of said substrate,

wherein said stamp of claim 1 is used therein.

8. (Amended) The method of claim 7, wherein
said stamp is cylindrical in shape, and
said stamp is rotated when being applied to the substrate
such that the entire printing face of the stamp is rolled over
the substrate.